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April 2014

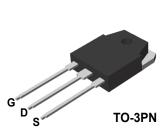
FDA8440 N-Channel Logic Level PowerTrench[®] MOSFET 40 V, 100 A, 2.1 m Ω

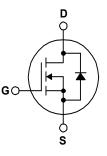
Features

- + $R_{DS(on)}$ = 1.46 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 80 A
- $Q_{G(tot)} = 345 \text{ nC} (Typ.) @ V_{GS} = 10 \text{ V}$
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- 160 A Guarantee for 2 sec
- RoHS Compliant

Application

- Power tools
- Motor drives and Uninterruptible Power Supplies
- Synchronous Rectification
- Battery Protection Circuit





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter	FDA8440	Unit	
V _{DSS}	Drain to Source Voltage	40	V	
V _{GSS}	Gate to Source Voltage	±20	V	
ID	Drain Current - Continuous (T _C = 155 ^o C)	100	А	
	- Continuous (T _A = 25°C, V _{GS} = 10 V, $R_{\theta JA}$ = 40°C/W)	30	А	
	- Pulsed	500	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 1	1682	mJ	
D	Power dissipation	306	W	
P _D	Derate above 25°C	2.04	W/ºC	
T _{J,} T _{STG}	Operating and Storage Temperature	-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.49	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 2)	40	°C/W

Part Number Top Mark		Package	Package Packing Method Reel Siz		ze Tape Width		n Qu	Quantity	
FDA8	3440	FDA8440	TO-3PN	Tube	N/A		N/A	30) units
Electric	al Chai	racteristics T _c = 25°C	unless otherwise	e noted					
Symbol		Parameter		Conditio	ns	Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV _{DSS}	Drain to S	Source Breakdown Voltage	V _{GS} =	0 V, I _D = 250 μA		40			V
I _{DSS} Zero Gate		e Voltage Drain Current	V _{DS} =	32 V				1	μA
			V _{GS} =	0 V	T _C = 150 ^o C			250	μA
I _{GSS}	Gate to B	ody Leakage Current	V _{GS} =	±20 V	•			±100	nA
On Charac	teristics								
V _{GS(th)}	Gate to S	ource Threshold Voltage	V _{DS} =	V _{GS} , I _D = 250 μA	l l	1		3	V
			V _{GS} =	4.5 V, I _D = 80 A			1.56	2.2	
R _{DS(on)}	Static Dra	Drain-Source On-Resistance $ \begin{array}{c} V_{GS} = 10 \text{ V}, \text{ I}_{D} = 80 \text{ A} \\ \\ V_{GS} = 10 \text{ V}, \text{ I}_{D} = 80 \text{ A}, \\ \\ T_{C} = 175^{\circ}\text{C} \end{array} $		V _{GS} = 10 V, I _D = 80 A			1.46	2.1	mΩ
						2.82	4.1		
Dynamic C	haracteris	tics					-		
C _{iss}	Input Cap	Tapacitance $V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz				18600	24740	pF	
C _{oss}	Output Ca			V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz			1840	2450	pF
C _{rss}	Reverse	Transfer Capacitance					1400	2100	pF
R _G	Gate Res	istance	V _{GS} =	V _{GS} = 0.5 V, f = 1 MHz			1.1		Ω
Q _{g(tot)}	Total Gate	e Charge at 10V	V _{GS} =	0 V to 10 V			345	450	nC
Q _{g(2)}	Threshold	d Gate Charge	V _{GS} =	0 V to 2 V	V _{DD} = 20 V		32.5		nC
Q _{gs}	Gate to S	ource Gate Charge			I _D = 80 A		49		nC
Q _{gs2}	Gate Cha	narge Threshold to Plateau			l _g = 1.0 mA		16.5		nC
Q _{gd}	Gate to Drain "Miller" Charge						74		nC
Switching	Characteri	stics							
t _{ON}	Turn-On	Time		V_{DD} = 20 V,I _D = 80 A V _{GS} = 10 V, R _{GEN} = 7 Ω			175	360	ns
t _{d(on)}	Turn-On I	Delay Time	Vpp =				43	95	ns
t _r	Rise Time						130	275	ns
t _{d(off)}	Turn-Off I	Delay Time					435	875	ns
t _f	Fall Time						290	590	ns
t _{OFF}	F Turn-Off Time						730	1470	ns
Drain-Sour	ce Diode (Characteristics and Maxir	num Ratings	6			1	I	
V _{SD}	Source to	Drain Diode Voltage	I _{SD} = 8					1.25	V
50		_	I _{SD} = 4					1.0	V
t _{rr}	Reverse	Recovery Time	I _{SD} = 7	′5 A, dI _{SD} /dt = 10	0 A/μs		59		ns
Q _{RR}	Reverse	Recovery Charge	I _{SD} = 7	′5 A, dI _{SD} /dt = 10	0 A/µs		77		nC

FDA8440 N-Channel Logic Level PowerTrench[®] MOSFET

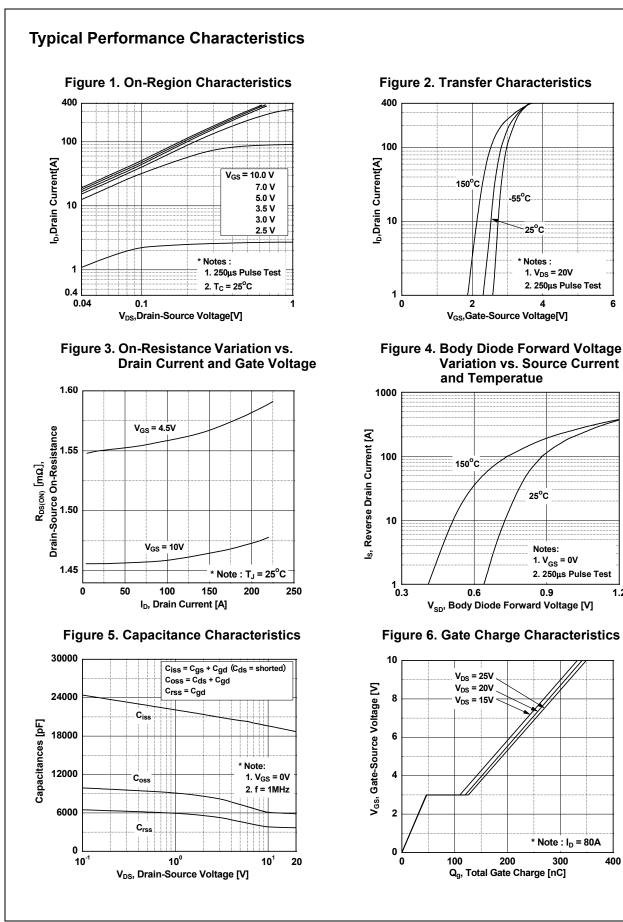
NOTES:

1: Starting T_J = 25°C, L = 1 mH, I_{AS} = 58 A, V_{DD} = 36 V, V_{GS} = 10 V. 2: Pulse width = 100 s.

∠. Puise width =

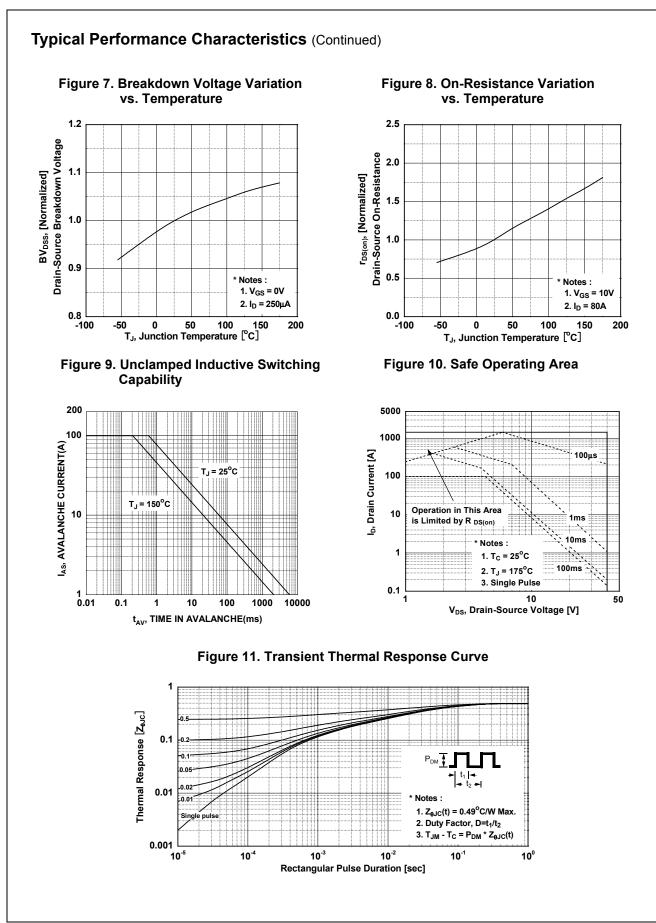
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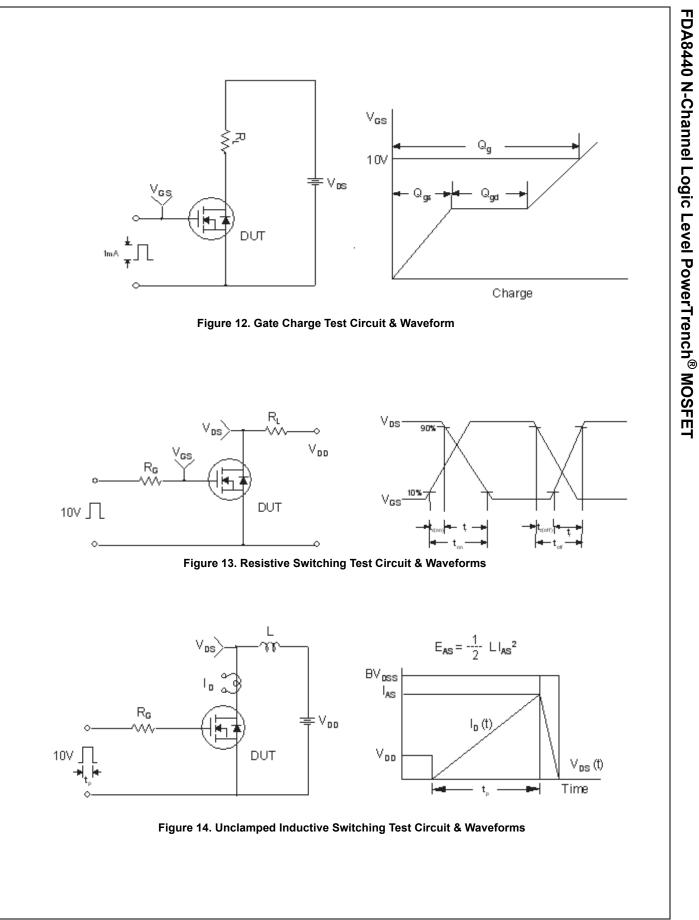
1.2



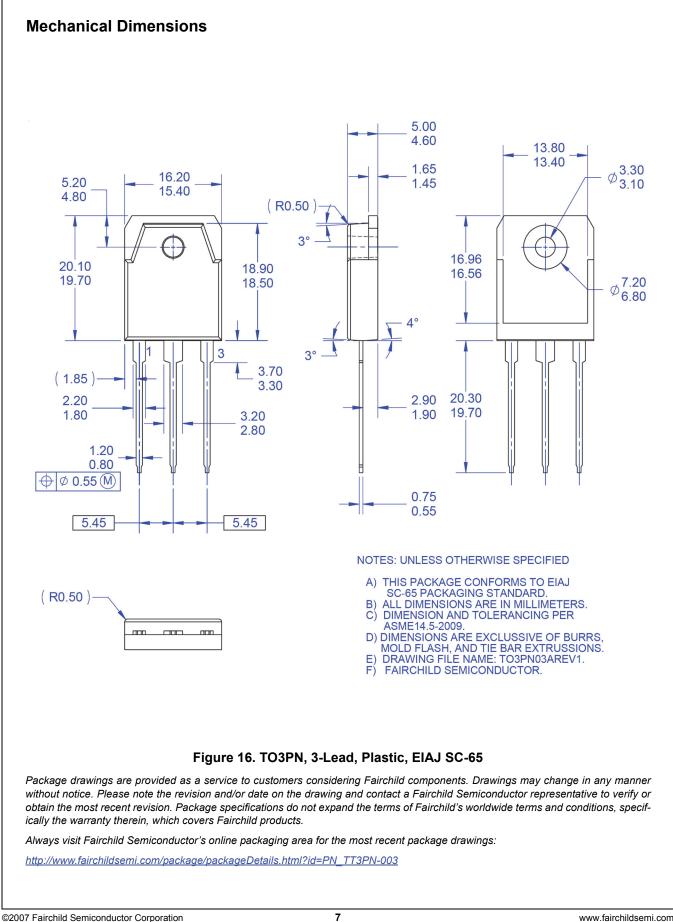
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DUT + H √os ¢ Isd 9 L KV Driver Re Same Type as DUT ‡ vm \sim __[[∨_{cs} - dv/dt controlled by $R_{\rm G}$ - $\mathsf{I}_{\scriptscriptstyle{\mathrm{SD}}}$ controlled by pulse period t Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) I_{FM} , Body Diode Forward Current I _{SD} (DUT) di∕dt l_{rm} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt Ť Vpp Vso Body Diode Forward Voltage Drop Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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